Analog Devices Inc./Maxim Integrated - ZLP32300S2832C00TR Datasheet

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, HLVD, POR, WDT
Number of I/O	24
Program Memory Size	32KB (32K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/analog-devices/zlp32300s2832c00tr

Development Features

Table 2 lists the features of Crimzon ZLP32300 family.

Table 2. Crimzon ZLP32300 MCU Features

Device	OTP(KB)	RAM* (Bytes)	I/O Lines	Voltage Range
Crimzon ZLP32300	8, 16, 32	237	32, 24 or 16	2.0–3.6 V
*General purpose				

The additional features include:

- Low power consumption–11 mW (typical)
- Three standby modes:
  - STOP—1.7 µA (typical)
  - HALT—0.6 mA (typical)
  - Low-voltage reset
- Special architecture to automate both generation and reception of complex pulses or signals:
  - One programmable 8-bit counter/timer with two capture registers and two load registers
  - One programmable 16-bit counter/timer with one 16-bit capture register pair and one 16-bit load register pair
  - Programmable input glitch filter for pulse reception
- Six priority interrupts
  - Three external
  - Two assigned to counter/timers
  - One Low-Voltage Detection interrupt
- Low-Voltage Detection and high voltage detection Flags
- Programmable Watchdog Timer/Power-On Reset (WDT/POR) circuits
- Two independent comparators with programmable interrupt polarity
- Programmable EPROM options
  - Port 0: 0–3 pull-up transistors
  - Port 0: 4–7 pull-up transistors
  - Port 1: 0–3 pull-up transistors
  - Port 1: 4–7 pull-up transistors

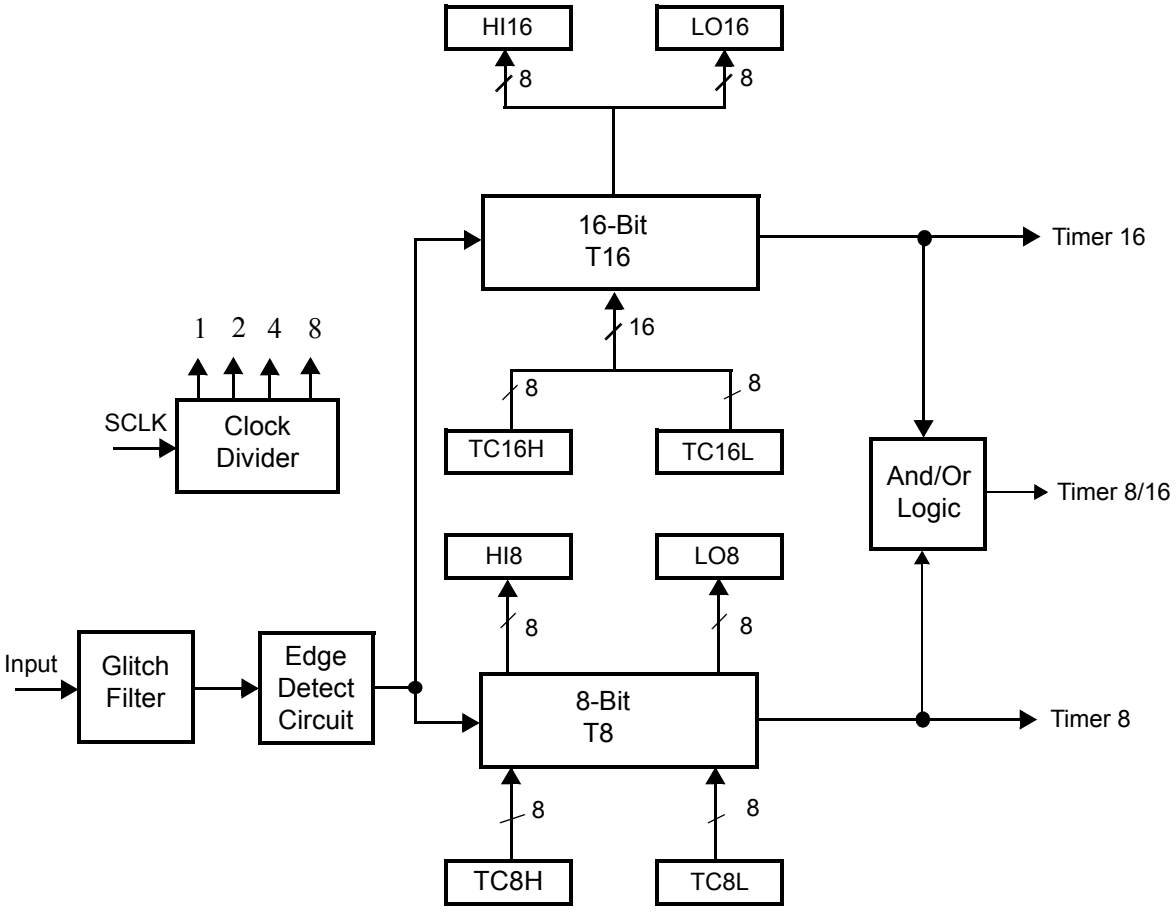


Figure 2. Counter/Timers Diagram

Pin Description

The pin configuration for the 20-pin PDIP/SOIC/SSOP is displayed in Figure 3 and described in Table 3. The pin configuration for the 28-pin PDIP/SOIC/SSOP are depicted in Figure 4 and described in Table 4. The pin configurations for the 40-pin PDIP and 48-pin SSOP versions are displayed in Figure 5, Figure 6, and described in Table 5.

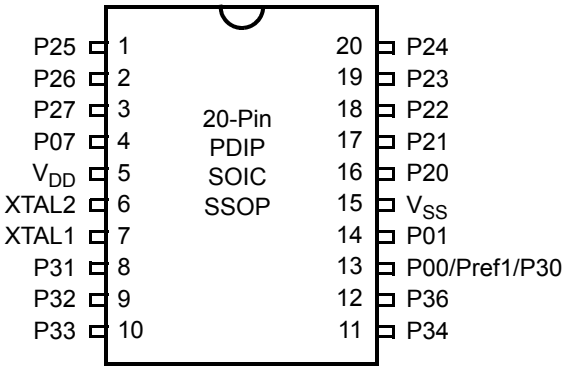


Figure 3. 20-Pin PDIP/SOIC/SSOP Pin Configuration

Table 3. 20-Pin PDIP/SOIC/SSOP Pin Identification

Pin No	Symbol	Function	Direction
1–3	P25–P27	Port 2, Bits 5,6,7	Input/Output
4	P07	Port 0, Bit 7	Input/Output
5	V_{DD}	Power Supply	
6	XTAL2	Crystal Oscillator Clock	Output
7	XTAL1	Crystal Oscillator Clock	Input
8–10	P31–P33	Port 3, Bits 1,2,3	Input
11,12	P34, P36	Port 3, Bits 4,6	Output
13	P00/Pref1/P30	Port 0, Bit 0/Analog reference input Port 3 Bit 0	Input/Output for P00 Input for Pref1/P30
14	P01	Port 0, Bit 1	Input/Output
15	V_{SS}	Ground	
16–20	P20–P24	Port 2, Bits 0,1,2,3,4	Input/Output

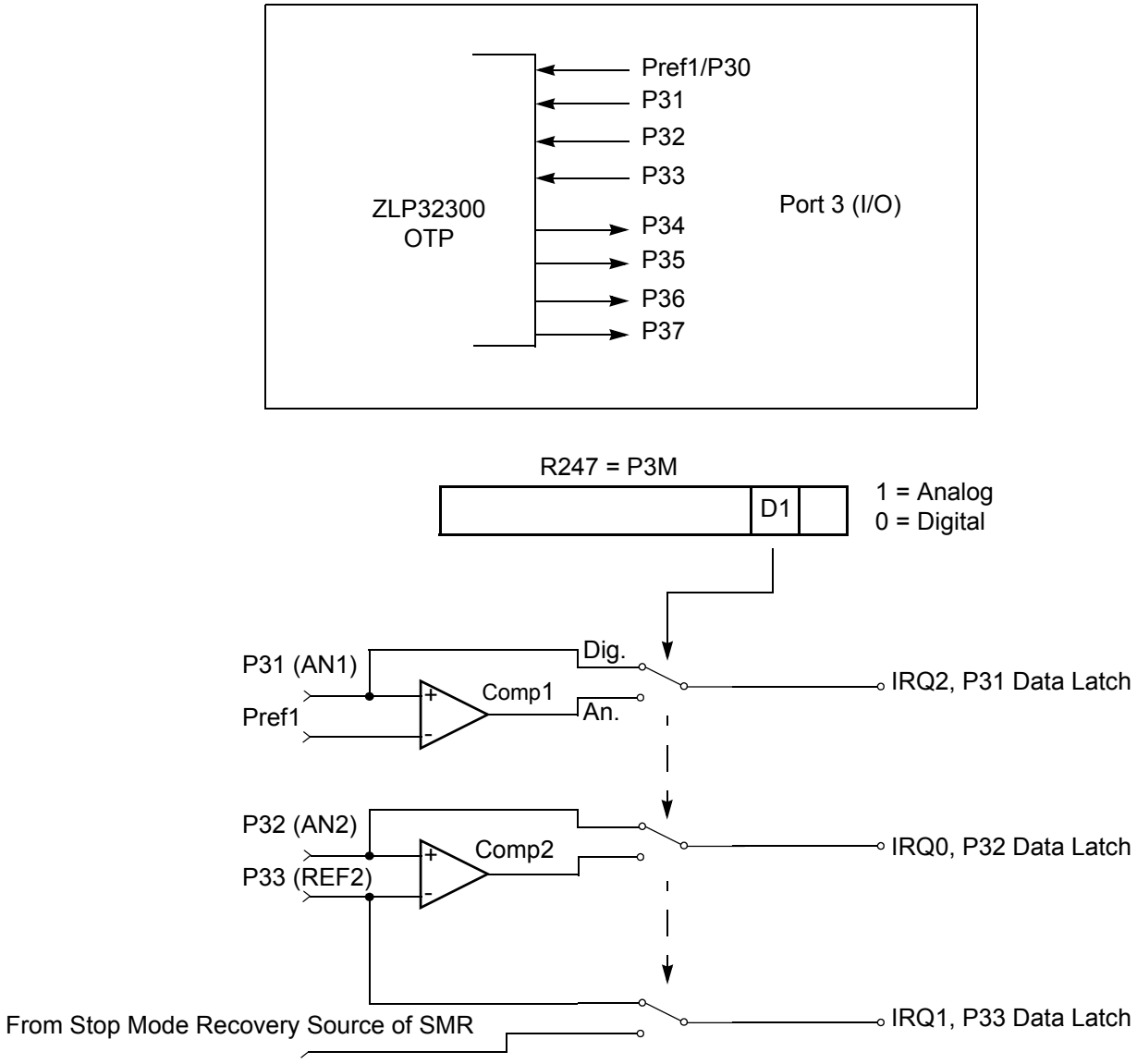


Figure 10. Port 3 Configuration

Two on-board comparators process analog signals on P31 and P32, with reference to the voltage on Pref1 and P33. The Analog function is enabled by programming the Port 3 Mode Register (bit 1). P31 and P32 are programmable as rising, falling, or both edge triggered interrupts (IRQ register bits 6 and 7). Pref1 and P33 are the comparator reference voltage inputs. Access to the Counter Timer edge-detection circuit is through P31 or P20

register RP select the working register group. Bits 3–0 of register RP select the expanded register file bank.

Note: *An expanded register bank is also referred to as an expanded register group (see* Figure 13*).*

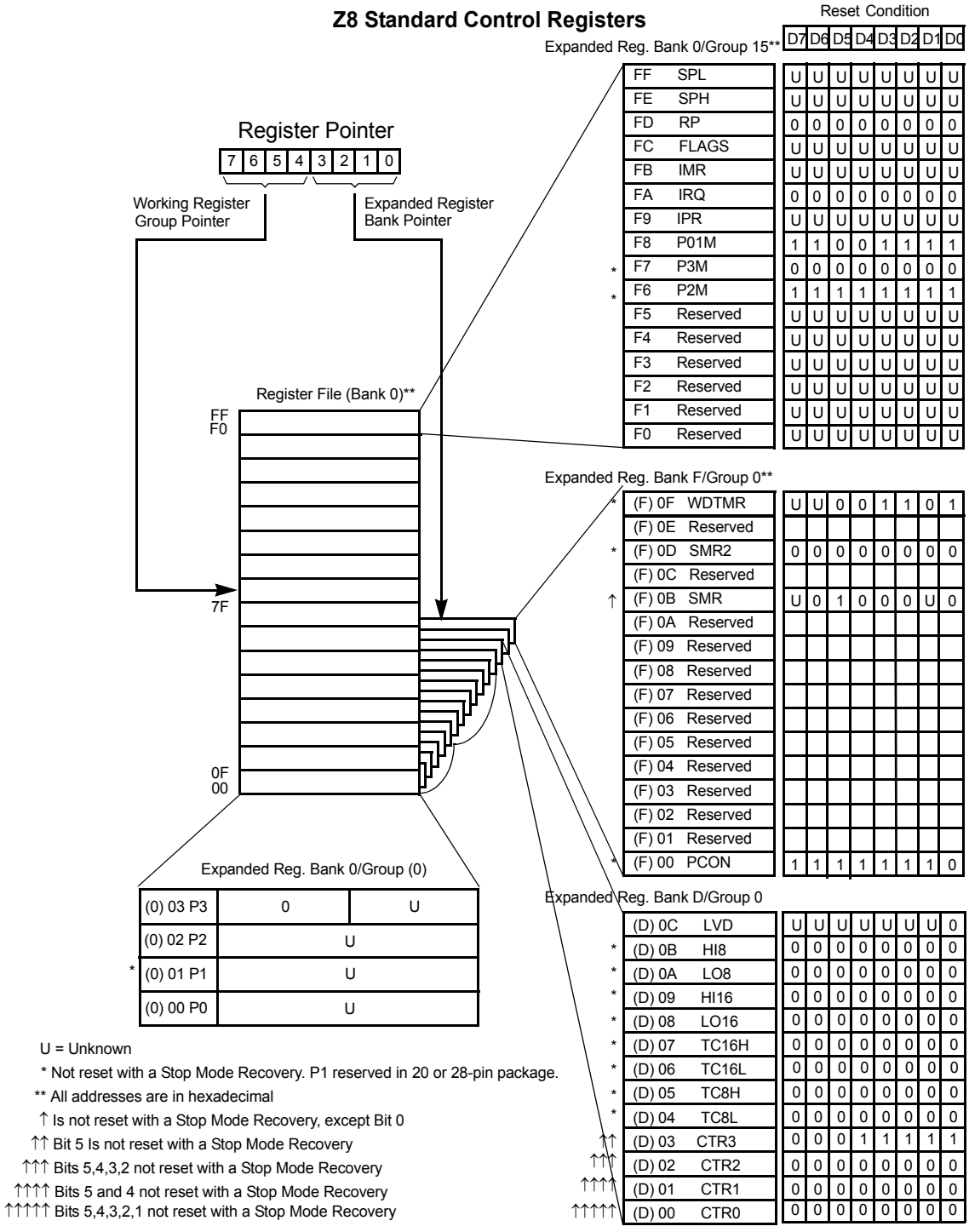


Figure 13. Expanded Register File Architecture

T8_Capture_LO—L08(D)0Ah

This register holds the captured data from the output of the 8-bit Counter/Timer0. Typically, this register holds the number of counts when the input signal is 0.

Field	Bit Position		Description
T8_Capture_L0	[7:0]	R/W	Captured Data—No Effect

T16_Capture_HI—HI16(D)09h

This register holds the captured data from the output of the 16-bit Counter/Timer16. This register holds the MS-Byte of the data.

Field	Bit Position		Description
T16_Capture_HI	[7:0]	R/W	Captured Data—No Effect

T16_Capture_LO—L016(D)08h

This register holds the captured data from the output of the 16-bit Counter/Timer16. This register holds the LS-Byte of the data.

Field	Bit Position		Description
T16_Capture_LO	[7:0]	R/W	Captured Data—No Effect

Counter/Timer2 MS-Byte Hold Register—TC16H(D)07h

Field	Bit Position		Description
T16_Data_HI	[7:0]	R/W	Data

Counter/Timer2 LS-Byte Hold Register—TC16L(D)06h

Field	Bit Position		Description
T16_Data_LO	[7:0]	R/W	Data

counter/timers (see Table 11 on page 45) and one for low-voltage detection. The Interrupt Mask Register (globally or individually) enables or disables the six interrupt requests.

The source for IRQ is determined by bit 1 of the Port 3 mode register (P3M). When in DIGITAL mode, Pin P33 is the source. When in ANALOG mode, the output of the Stop Mode Recovery source logic is used as the source for the interrupt, see Figure 33 on page 52.

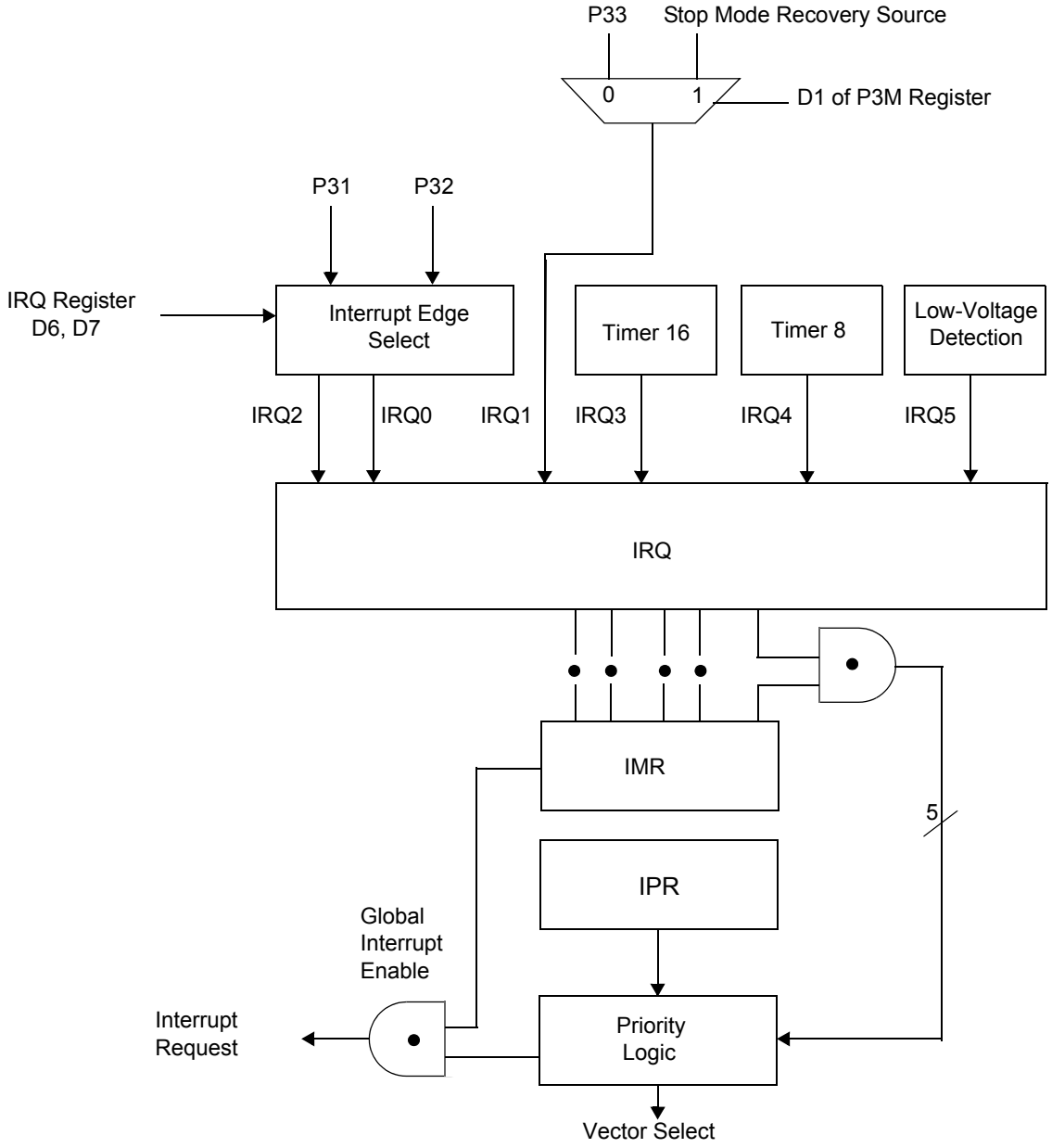
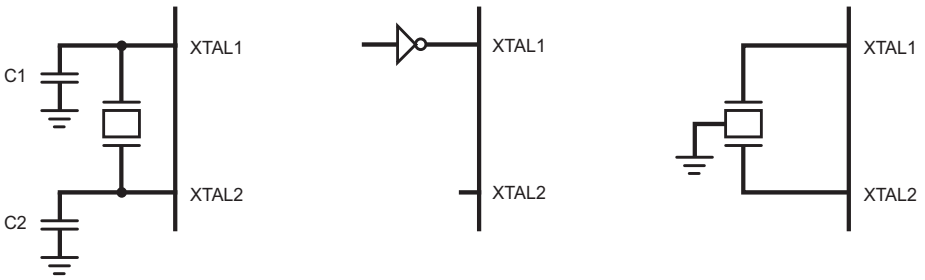


Figure 28. Interrupt Block Diagram

Clock

The device's on-chip oscillator has a high-gain, parallel-resonant amplifier, for connection to a crystal, ceramic resonator, or any suitable external clock source (XTAL1 = Input, XTAL2 = Output). The crystal must be AT cut, 1 MHz to 8 MHz maximum, with a series resistance (RS) less than or equal to 100 Ω. The on-chip oscillator can be driven with a suitable external clock source.

The crystal must be connected across XTAL1 and XTAL2 using the recommended capacitors from each pin to ground. The typical capacitor value is 10 pF for 8 MHz. Also check with the crystal supplier for the optimum capacitance.



Crystal
C1, C2 = 10 pF *
f = 8 MHz

External Clock

Ceramic Resonator f = 8 MHz

*Note: preliminary value.

Figure 29. Oscillator Configuration

Zilog's IR MCU supports crystal, resonator, and oscillator. Most resonators have a frequency tolerance of less than ±0.5%, which is enough for remote control application. Resonator has a very fast startup time, which is around few hundred microseconds. Most crystals have a frequency tolerance of less than 50 ppm (±0.005%). However, crystal needs longer startup time than the resonator. The large loading capacitance slows down the oscillation startup time. Zilog® suggests not to use more than 10 pF loading capacitor for the crystal. If the stray capacitance of the PCB or the crystal is high, the loading capacitance C1 and C2 must be reduced further to ensure stable oscillation before the T_{POR} (Power-On Reset time is typically 5-6 ms, see Table 20 on page 79).

For Stop Mode Recovery operation, bit 5 of SMR register allows you to select the Stop Mode Recovery delay, which is the T_{POR}. If Stop Mode Recovery delay is not selected, the MCU executes instruction immediately after it wakes up from the STOP mode. If resonator or crystal is used as a clock source then Stop Mode Recovery delay needs to be selected (bit 5 of SMR = 1).

SCLK/TCLK Divide-by-16 Select (D0)

D0 of the SMR controls a divide-by-16 prescaler of SCLK/TCLK (see Figure 32). This control selectively reduces device power consumption during normal processor execution (SCLK control) and/or HALT mode (where TCLK sources interrupt logic). After Stop Mode Recovery, this bit is set to a 0.

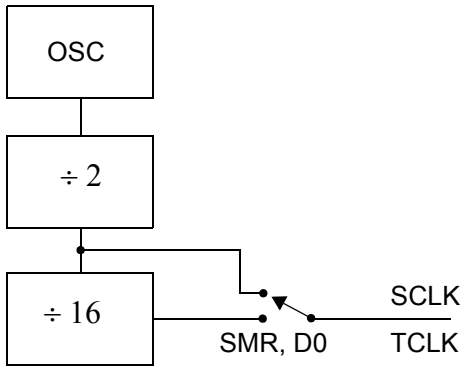


Figure 32. SCLK Circuit

Stop Mode Recovery Source (D2, D3, and D4)

These three bits of the SMR specify the wake-up source of the Stop recovery (see Figure 33 and Table 14).

Stop Mode Recovery Register 2—SMR2(F)0Dh

Table 13 lists and briefly describes the fields for this register.

Table 13. SMR2(F)0Dh:Stop Mode Recovery Register 2*

Field	Bit Position		Value	Description
Reserved	7-------		0	Reserved (Must be 0)
Recovery Level	-6------	W	0†	Low
			1	High
Reserved	--5-----		0	Reserved (Must be 0)

WDT Time Select (D0, D1)

This bit selects the WDT time period. It is configured as indicated in Table 15.

Table 15. Watchdog Timer Time Select

D1	D0	Timeout of Internal RC-Oscillator
0	0	5 ms min
0	1	10 ms min
1	0	20 ms min
1	1	80 ms min

WDTMR During Halt (D2)

This bit determines whether or not the WDT is active during HALT mode. A 1 indicates active during HALT. The default is 1, see Figure 36.

Table 16. EPROM Selectable Options

Port 00–03 Pull-Ups	ON/OFF
Port 04–07 Pull-Ups	ON/OFF
Port 10–13 Pull-Ups	ON/OFF
Port 14–17 Pull-Ups	ON/OFF
Port 20–27 Pull-Ups	ON/OFF
EPROM Protection	ON/OFF
Watchdog Timer at Power-On Reset	ON/OFF

Voltage Brownout/Standby

An on-chip Voltage Comparator checks that the V_{DD} is at the required level for correct operation of the device. Reset is globally driven when V_{DD} falls below V_{BO}. A small drop in V_{DD} causes the XTAL1 and XTAL2 circuitry to stop the crystal or resonator clock. If the V_{DD} is allowed to stay above V_{RAM}, the RAM content is preserved. When the power level is returned to above V_{BO}, the device performs a POR and functions normally.

Low-Voltage Detection

Low-Voltage Detection Register—LVD(D)0Ch

Note: *Voltage detection does not work at STOP mode.*

Field	Bit Position			Description
LVD	76543---			Reserved No Effect
	-----2--	R	1 0*	HVD Flag set HVD Flag reset
	------1-	R	1 0*	LVD Flag set LVD Flag reset
	-------0	R/W	1 0*	Enable VD Disable VD
*Default after POR				

Note: *Do not modify register P01M while checking a low-voltage condition. Switching noise of both Ports 0 and 1 together might trigger the LVD Flag.*

R249 IPR(F9H)

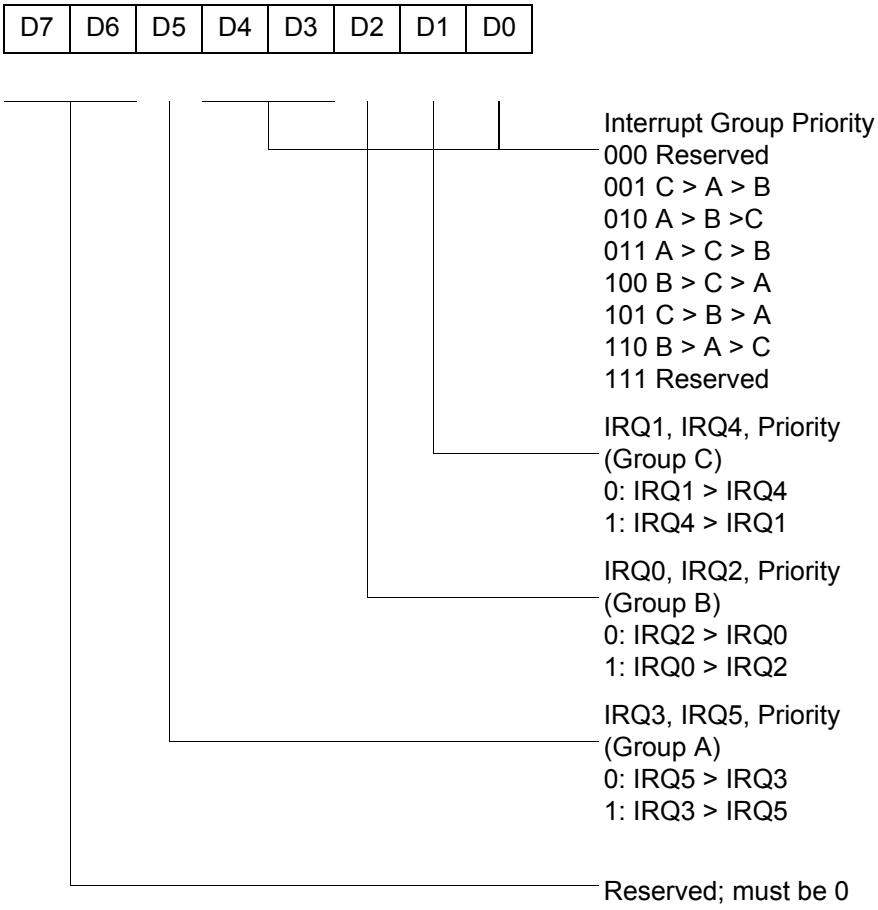


Figure 49. Interrupt Priority Register (F9H: Write Only)

R252 Flags(FCH)

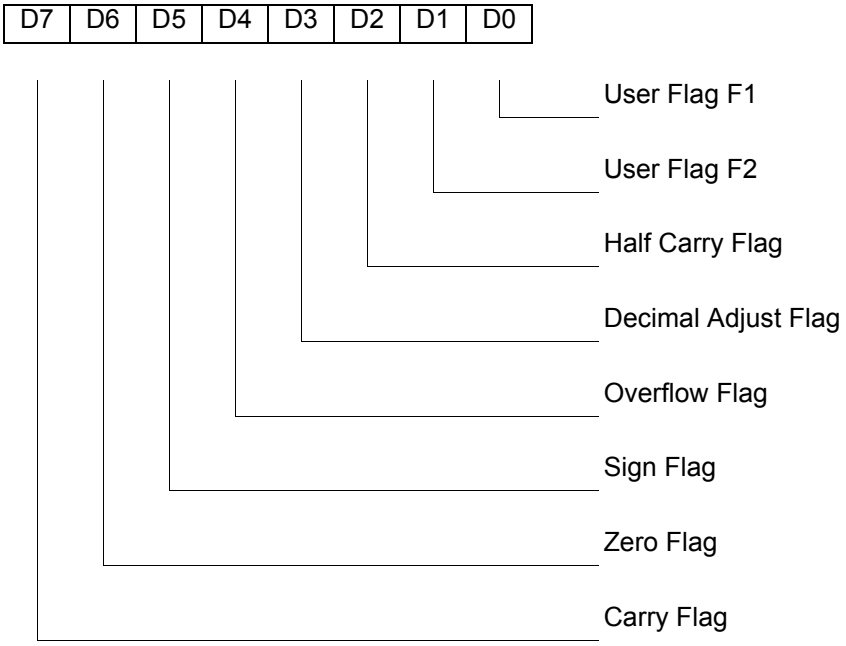
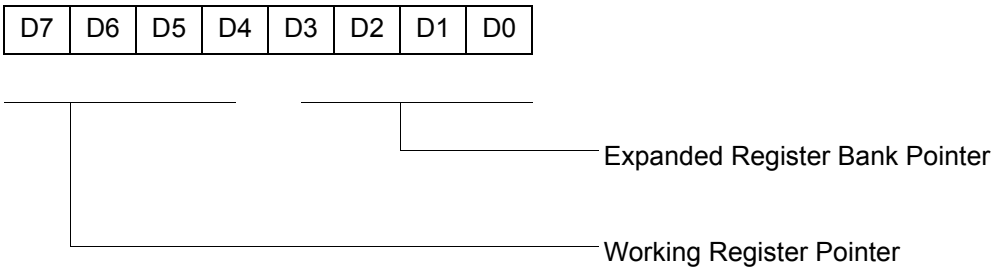


Figure 52. Flag Register (FCH: Read/Write)

R253 RP(FDH)



Default setting after reset = 0000 0000

Figure 53. Register Pointer (FDH: Read/Write)

R254 SPH(FEH)

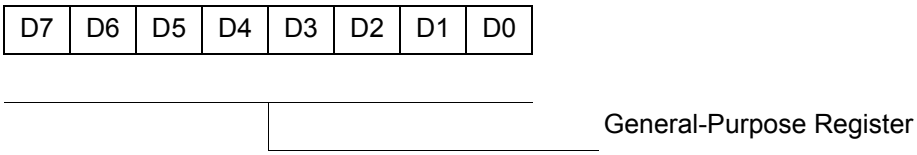


Figure 54. Stack Pointer High (FEH: Read/Write)

R255 SPL(FFH)

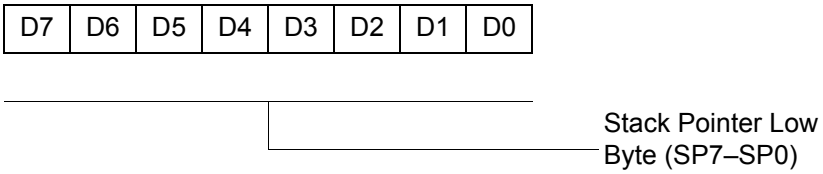


Figure 55. Stack Pointer Low (FFH: Read/Write)

Capacitance

Table 18 lists the capacitances.

Table 18. Capacitance

Parameter	Maximum
Input capacitance	12 pF
Output capacitance	12 pF
I/O capacitance	12 pF
T_A = 25 °C, V_{CC} = GND = 0 V, f = 1.0 MHz, unmeasured pins returned to GND	

DC Characteristics

Table 19 describes the DC characteristics.

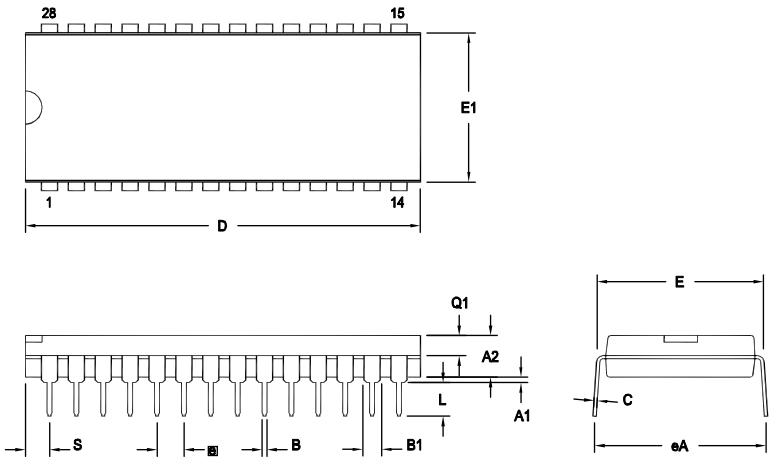
Table 19. DC Characteristics

			T_A= 0 °C to +70 °C					
Symbol	Parameter	V_{CC}	Min	Typ(7)	Max	Units	Conditions	Notes
V_{CC}	Supply Voltage		2.0		3.6	V	See Notes	5
V_{CH}	Clock Input High Voltage	2.0-3.6	0.8 V_{CC}		V_{CC}+0.3	V	Driven by External Clock Generator	
V_{CL}	Clock Input Low Voltage	2.0-3.6	V_{SS}–0.3		0.4	V	Driven by External Clock Generator	
V_{IH}	Input High Voltage	2.0-3.6	0.7 V_{CC}		V_{CC}+0.3	V		
V_{IL}	Input Low Voltage	2.0-3.6	V_{SS}–0.3		0.2 V_{CC}	V		
V_{OH1}	Output High Voltage	2.0-3.6	V_{CC}–0.4			V	I_{OH} = –0.5 mA	
V_{OH2}	Output High Voltage (P36, P37, P00, P01)	2.0-3.6	V_{CC}–0.8			V	I_{OH} = –7 mA	
V_{OL1}	Output Low Voltage	2.0-3.6			0.4	V	I_{OL} = 4.0 mA	
V_{OL2}	Output Low Voltage (P00, P01, P36, P37)	2.0-3.6			0.8	V	I_{OL} = 10 mA	
V_{OFFSET}	Comparator Input Offset Voltage	2.0-3.6			25	mV		
V_{REF}	Comparator Reference Voltage	2.0-3.6	0		V_{CC} -1.75	V		

Table 20. AC Characteristics

			T_A=0 °C to +70 °C 8.0 MHz					Watchdog Timer Mode Register (D1, D0)
No	**Symbol**	**Parameter**	**V_{CC}**	**Minimum**	**Maximum**	**Units**	**Notes**	
1	TpC	Input Clock Period	2.0–3.6	121	DC	ns	1	
2	TrC,TfC	Clock Input Rise and Fall Times	2.0–3.6		25	ns	1	
3	TwC	Input Clock Width	2.0–3.6	37		ns	1	
4	TwTinL	Timer Input Low Width	2.0 3.6	100 70		ns	1	
5	TwTinH	Timer Input High Width	2.0–3.6	3TpC			1	
6	TpTin	Timer Input Period	2.0–3.6	8TpC			1	
7	TrTin,TfTin	Timer Input Rise and Fall Timers	2.0–3.6		100	ns	1	
8	TwIL	Interrupt Request Low Time	2.0 3.6	100 70		ns	1, 2	
9	TwIH	Interrupt Request Input High Time	2.0–3.6	5TpC			1, 2	
10	Twsm	Stop Mode Recovery Width Spec	2.0–3.6	12 10TpC		ns	3 4	
11	Tost	Oscillator Start-Up Time	2.0–3.6		5TpC		4	
12	Twdt	Watchdog Timer Delay Time	2.0–3.6 2.0–3.6 2.0–3.6 2.0–3.6	5 10 20 80		ms ms ms ms		0, 0 0, 1 1, 0 1, 1
13	T_{POR}	Power-on reset	2.0–3.6	2.5	10	ms		

Notes
1. Timing Reference uses 0.9 V_{CC} for a logic 1 and 0.1 V_{CC} for a logic 0.
2. Interrupt request through Port 3 (P33–P31).
3. SMR–D5 = 1.
4. SMR–D5 = 0.



SYMBOL	OPT #	MILLIMETER		INCH	
		MIN	MAX	MIN	MAX
A1		0.38	1.02	.015	.040
A2		3.18	4.19	.125	.165
B		0.38	0.53	.015	.021
B1	01	1.40	1.65	.055	.065
	02	1.14	1.40	.045	.055
C		0.23	0.38	.009	.015
D	01	36.58	37.34	1.440	1.470
	02	35.31	35.94	1.390	1.415
E		15.24	15.75	.600	.620
E1	01	13.59	14.10	.535	.555
	02	12.83	13.08	.505	.515
e		2.54 TYP		.100 BSC	
eA		15.49	16.76	.610	.660
L		3.05	3.81	.120	.150
Q1	01	1.40	1.91	.055	.075
	02	1.40	1.78	.055	.070
S	01	1.52	2.29	.060	.090
	02	1.02	1.52	.040	.060

CONTROLLING DIMENSIONS : INCH

OPTION TABLE	
OPTION #	PACKAGE
01	STANDARD
02	IDF

Note: ZiLOG supplies both options for production. Component layout PCB design should cover bigger option 01.

Figure 62. 28-Pin PDIP Package Diagram

Index

Numerics

A

B

C

D

S

T

V

W

X

Z